NOTES:
1. LEAK TEST: 3000 PSI, NO BUBBLES 30 SECONDS MINIMUM.
2. HYTOP 630 VDC 500 MEGOHMS MINIMUM 0.01SECOND MINIMUM WIRE TO WIRE.
3. ALL TESTS ARE PERFORMED AT ROOM TEMPERATURE.
4. ALL PARTS MUST PASS ALL TESTS.
5. WIRE POSITIONING IS APPROXIMATE & VARIABLE.
6. NO VOIDS ARE ACCEPTABLE ON O-RING SEALING SURFACES, VOIDS SMALLER THAN 0.035 ARE ACCEPTABLE ON ALL OTHER SURFACES.
7. REF-OPERATING TEMPERATURE -20°C TO 125°C.